

# **Voltage Detector**

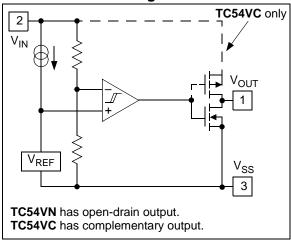
#### **Features**

- Precise Detection Thresholds: Standard ±2.0%, Custom ±1.0%
- Small Packages: 3-Pin SOT-23A, 3-Pin SOT-89, TO-92 and 5-Pin SOT-23A (7.7V only)
- Low Current Drain: Typ. 1 μA
- Wide Detection Range: 1.1V to 6.0V and 7.7V
- Wide Operating Voltage Range: 0.7V to 10V

### **Applications**

- · Battery Voltage Monitoring
- Microprocessor Reset
- · System Brown-Out Protection
- · Switching Circuit in Battery Backup
- · Level Discriminator

### **Functional Block Diagram**



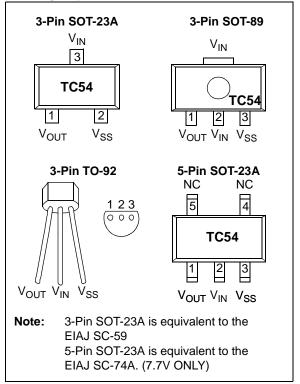
### **General Description**

The TC54 series are CMOS voltage detectors that are especially well suited for battery-powered applications because of their extremely low 1  $\mu$ A operating current and small surface-mount packaging. Each part is laser-trimmed to the desired threshold voltage, which can be specified from 1.4V to 7.7V for a 2% tolerance and from 1.5V to 6.0V for a 1% tolerance.

The device includes a comparator, low-current highprecision reference, laser-trimmed divider, hysteresis circuit and output driver. The TC54 is available with either an open-drain or complementary output stage.

During operation, the TC54's output ( $V_{OUT}$ ) remains in the logic-high state as long as  $V_{IN}$  is greater than the specified threshold voltage ( $V_{DET}$ –). When  $V_{IN}$  falls below  $V_{DET}$ –, the output is driven to a logic-low.  $V_{OUT}$  remains low until  $V_{IN}$  rises above  $V_{DET}$ – by an amount  $V_{HYST}$ , whereupon it resets to a logic-high.

### Package Types



# 1.0 ELECTRICAL CHARACTERISTICS

### **Absolute Maximum Ratings †**

Input Voltage	+12V
Output Current	50 mA
Output Voltage: CMOSOpen-Drain	$(V_{SS} - 0.3V)$ to $(V_{IN} + 0.3V)$ $(V_{SS} - 0.3V)$ to 12V
Power Dissipation ( $T_A \le 70^{\circ}$ C): 3-Pin SOT-23A	500 mW 240 mW
Operating Temperature Range	40°C to +85°C
Storage Temperature Range	65°C to +150°C

† Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions above those indicated in the operation sections of the specifications is not implied. Exposure to Absolute Maximum Rating conditions for extended periods may affect device reliability.

### **PIN FUNCTION TABLE**

Symbol	Description
V <sub>OUT</sub>	Digital Output
V <sub>IN</sub>	Analog Input
V <sub>SS</sub>	Ground Terminal
NC	No Connect
NC	No Connect

### **DC CHARACTERISTICS**

Electrical Specifications: Unless otherwise noted, T <sub>A</sub> = +25°C.						
Parameter	Sym	Min	Тур	Max	Units	Test Conditions
Operating Voltage	V <sub>IN</sub>	0.7	_	10.0	V	$(V_{DET} -) = 0.8 \text{ to } 6.0 \text{V}$
Quiescent Current	I <sub>SS</sub>	_	0.8	2.7	μΑ	V <sub>IN</sub> = 2.0V
		_	0.9	3.0		V <sub>IN</sub> = 3.0V
		_	1.0	3.2		V <sub>IN</sub> = 4.0V
		_	1.1	3.6		V <sub>IN</sub> = 5.0V
Threshold Voltage	V <sub>DET</sub> -	1.37	1.4	1.43	V	TC54VX14
(Note 1)		2.06	2.1	2.14		TC54VX21
		2.65	2.7	2.75		TC54VX27
		2.84	2.9	2.96		TC54VX29
		2.94	3.0	3.06		TC54VX30
		4.12	4.2	4.28		TC54VX42
		4.21	4.3	4.39		TC54VX43
		7.54	7.7	7.86		TC54VX77 (5-pin SOT-23A only)
Hysteresis Voltage	V <sub>HYST</sub>	28	70	112	mV	$V_{DET} = 1.4V (typ)$
		42	105	168		$V_{DET} = 2.1V \text{ (typ)}$
		54	135	216		$V_{DET} = 2.7V \text{ (typ)}$
		58	145	232		$V_{DET} = 2.9V (typ)$
		60	150	240		$V_{DET} = 3.0V \text{ (typ)}$
		84	210	336		$V_{DET} = 4.2V \text{ (typ)}$
		86	215	344		$V_{DET} = 4.3V \text{ (typ)}$
		154	385	616		$V_{DET} = 7.7V \text{ (typ)}$
Output Current	I <sub>OUT</sub>	_	7.7	_	mA	$V_{OL} = 0.5V, V_{IN} = 2.1V$
		_	10.1	_		$V_{IN} = 3.0V$
			11.5	_		$V_{IN} = 4.0V$
			13.0	_		V <sub>IN</sub> = 5.0V
		_	-10.0	_		TC54VC Only: $V_{OH} = V_{IN} - 2.1V, V_{IN} = 8.0V$
Tempco of (V <sub>DET</sub> -)	T <sub>C</sub> (V <sub>DET</sub> –)	_	±100	_	ppm/°C	
Delay Time	t <sub>DLY</sub>	_	_	0.2	ms	$V_{DET} - \rightarrow V_{OUT}$ inversion

Note 1: For other voltage options, please contact your regional Microchip sales office.

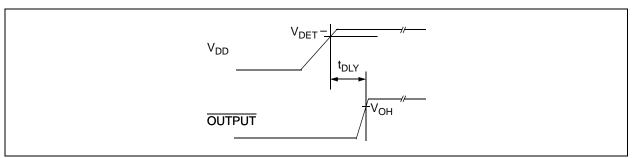


FIGURE 1-1: Timing Diagram.

### 2.0 PIN DESCRIPTIONS

The descriptions of the pins are listed in Table 2-1.

TABLE 2-1: PIN FUNCTION TABLE

Pin No. (3-Pin SOT-23A)	Pin No. (3-Pin SOT-89) (3-Pin TO-92)	Pin No. (5-Pin SOT-23A)	Symbol	Description
1	1	1	V <sub>OUT</sub>	Digital Output
3	2	2	V <sub>IN</sub>	Analog Input
2	3	3	$V_{SS}$	Ground Terminal
_	_	4	NC	No Connect
_	_	5	NC	No Connect

# 2.1 Digital Output (V<sub>OUT</sub>)

 $\rm V_{OUT}$  goes low when  $\rm V_{IN}$  drops below  $\rm V_{DET}-$  and returns high when  $\rm V_{IN}$  rises above  $\rm V_{DET}-+V_{HYST}$  (See Figure 3-1).

### 2.2 Analog Input (V<sub>IN</sub>)

 $\ensuremath{V_{\text{IN}}}$  can be used for power supply monitoring or a voltage level that requires monitoring.

# 2.3 Ground Terminal (V<sub>SS</sub>)

 $\mbox{$V_{SS}$}$  provides the negative reference for the analog input voltage. Typically, the circuit ground is used.

### 2.4 No Connect (NC)

No internal connection.

### 3.0 DETAILED DESCRIPTION

In normal steady-state operation when  $V_{IN} > V_{DET}$ , the output will be at a logic-high (see Figure 3-1). In the case of the TC54VN, this is an open-drain condition. If the input falls below  $V_{DET}$ , the output will pull down (Logic 0) to  $V_{SS}$ . Generally,  $V_{OUT}$  can pull down to within 0.5V of  $V_{SS}$  at rated output current and input voltage. (See **Section 1.0** "**Electrical Characteristics**").

The output (V<sub>OUT</sub>) will stay valid until the input voltage falls below the minimum operating voltage (V<sub>INMIN</sub>) of 0.7V. Below this minimum operating voltage the output is undefined. During power-up (or anytime V<sub>IN</sub> has fallen below V<sub>INMIN</sub>), V<sub>OUT</sub> will remain undefined until V<sub>IN</sub> rises above V<sub>INMIN</sub>. Once this occurs, the output will become valid. V<sub>OUT</sub> will be in its active-low state, while V<sub>INMIN</sub> < V<sub>IN</sub> < V<sub>DET</sub>+ (therefore, V<sub>DET</sub>+ = V<sub>DET</sub>- + V<sub>HYST</sub>). If the input rises above V<sub>DET</sub>+, the output will assume its inactive state (high for TC54VC, open-drain for TC54VN).

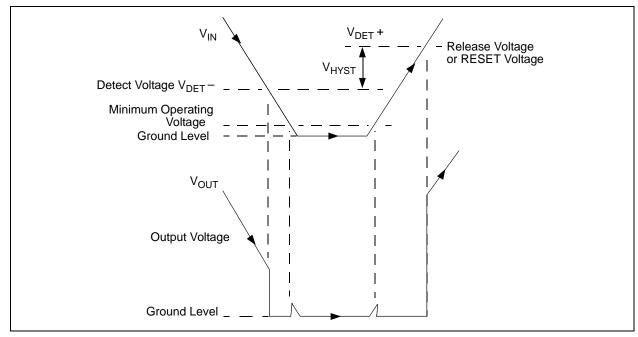


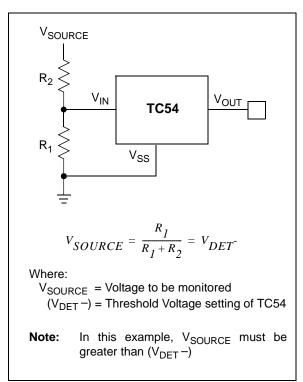
FIGURE 3-1: Timing Diagram.

#### 4.0 APPLICATIONS INFORMATION

### 4.1 Modifying The Trip Point, V<sub>DET</sub> –

Although the TC54 has a pre-programmed V $_{DET}$ -, it is sometimes necessary to make adjustments during prototyping. This can be accomplished by connecting an external resistor divider to a TC54, which has a V $_{DET}$ -lower than that of V $_{SOURCE}$  (Figure 4-1).

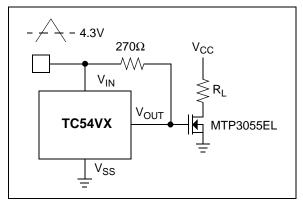
To maintain detector accuracy, the bleeder current through the divider should be significantly higher than the 1  $\mu\text{A}$  operating current required by the TC54. A reasonable value for this bleeder current is 100  $\mu\text{A}$  (100 times the 1  $\mu\text{A}$  required by the TC54). For example, if  $V_{DET}=2V$  and the desired trip point is 2.5V, the value of  $R_1+R_2$  is 25  $k\Omega$  (2.5V/100  $\mu\text{A}$ ). The value of  $R_1+R_2$  can be rounded to the nearest standard value and plugged into the equation of Figure 4-1 to calculate values for  $R_1$  and  $R_2$ . 1% tolerance resistors are recommended.



**FIGURE 4-1:** Modify trip-point of the TC54 using external resistor divider.

### 4.2 Other Applications

Low operating power and small physical size make the TC54 series ideal for many voltage detector applications, such as those shown in Figures 4-2, 4-3 and 4-4. Figure 4-2 shows a low-voltage gate drive protection circuit that prevents overheating of the logic-level MOSFET due to insufficient gate voltage. When the input signal is below the threshold of the TC54VN, its output grounds the gate of the MOSFET. Figure 4-3 and Figure 4-4 show the TC54 in conventional voltage monitoring applications.



**FIGURE 4-2:** MOSFET Low Drive Protection.

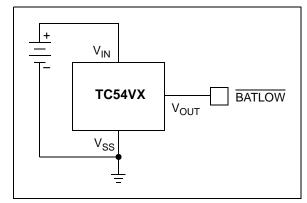


FIGURE 4-3: Battery Voltage Monitor.

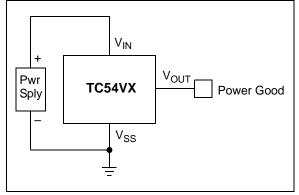
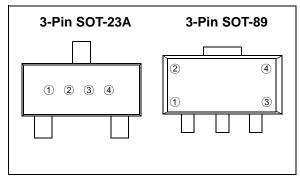


FIGURE 4-4: Power Good Monitor.

### 5.0 PACKAGING INFORMATION

# 5.1 Package Marking Information



 represents output configuration (CMOS or Nch) and first integer of voltage

Ex: CMOS 3.x = (D) () ()

Symbol	Output	Voltage
В	CMOS	1.
С	CMOS	2.
D	CMOS	3.
E	CMOS	4.
F	CMOS	5.
Н	CMOS	6.
I	CMOS	7.

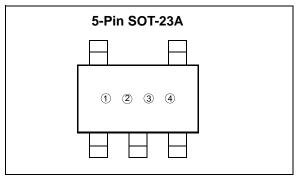
Symbol	Output	Voltage
L	Nch	1.
M	Nch	2.
N	Nch	3.
Р	Nch	4.
R	Nch	5.
S	Nch	6.
Т	Nch	7.

2 represents first decimal of output voltage (0-9)

Ex: CMOS 3.x = ① ④ 〇 〇

Symbol	Voltage	Symbol	Voltage
0	.0	6	.6
1	.1	7	.7
2	.2	8	.8
3	.3	9	.9
4	.4		
5	.5		

③ & ④ represents assembly lot code



represents output configuration and first integer of voltage

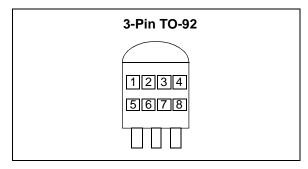
Symbol	Output	Voltage
Т	Nch	7.

2 represents first decimal of output voltage

Symbol	Voltage
0	.0
1	.1
2	.2
3	.3
4	.4
5	.5
6	.6
7	.7
8	.8
9	.9

③ & ④ represents assembly lot code

# **Package Marking Information (Continued)**



①, ②, & ③ = 54X (fixed)

④ represents output configuration (CMOS or Nch) Ex: CMOS 3.x = © ○ ○ ○

Symbol	Output
С	CMOS
N	N-Channel

⑤ represents first integer of detect voltage

Symbol	Voltage	
2	2.	
3	3.	
4	4.	
5	5.	
6	6.	

6 represents first decimal of detect voltage

Symbol	Voltage	Symbol	Voltage
0	.0	5	.5
1	.1	6	.6
2	.2	7	.7
3	.3	8	.8
4	.4	9	.9

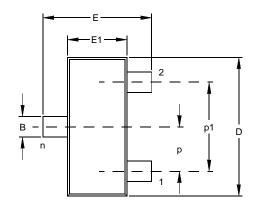
⑦ represents the output Delay Time

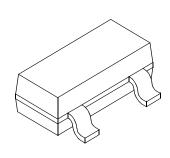
Symbol	Delay Time			
0	No Delay			

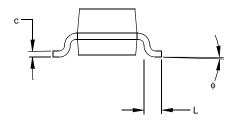
® respresents the device accuracy

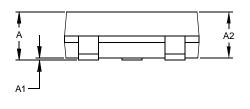
Symbol	Accuracy
1	±1.0% (custom)
2	±2.0% (standard)

# 3-Lead Plastic Small Outline Transistor (CB) (SOT23A)









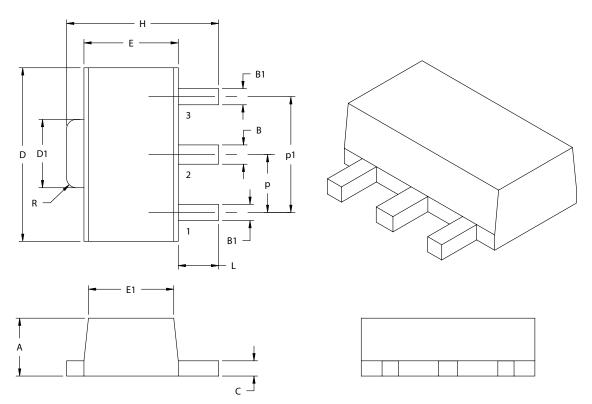
·	Units				М	MILLIMETERS*		
Dimen	sion Limits	MIN	NOM	MAX	MIN	NOM	MAX	
Number of Pins	n		3			3		
Pitch	р		.037			0.95		
Outside lead pitch (basic)	p1	.067	.075	.083	1.70	1.90	2.10	
Overall Height	Α	.035		.055	0.90	-	1.40	
Molded Package Thickness	A2	.035	-	.051	0.90	-	1.30	
Standoff	A1	.000	-	.004	0.00	-	0.10	
Overall Width	E	.098	_	.118	2.50	-	3.00	
Molded Package Width	E1	.055	_	.071	1.40	-	1.80	
Overall Length	D	.106	-	.122	2.70	-	3.10	
Foot Length	L	.014	-	.022	0.35	-	0.55	
Foot Angle	ф	0	_	10	0	_	10	
Lead Thickness	С	.004	_	.014	0.10	-	0.35	
Lead Width	В	.012	_	.019	0.30	_	0.50	

<sup>\*</sup>Controlling Parameter

Notes: Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .005" (0.127mm) per side.

EIAJ Equivalent: SC-59 Drawing No. C04-130

# 3-Lead Plastic Small Outline Transistor (MB) (SOT89)



	Units	INCH	IES	MILLIMETERS*		
Dimension Lim	its	MIN	MAX	MIN	MAX	
Pitch	р	.059 BSC		1.50 BS	SC	
Outside lead pitch (basic)	p1	.118 B	SC	3.00 BSC		
Overall Height	Α	.055	.063	1.40	1.60	
Overall Width	Н	.155	.167	3.94	4.25	
Molded Package Width at Base	Е	.090	.102	2.29	2.60	
Molded Package Width at Top	E1	.084	.090	2.13	2.29	
Overall Length	D	.173	.181	4.40	4.60	
Tab Length	D1	.064	.072	1.62	1.83	
Tab Corner Radii	R	.01	0	0.254		
Foot Length	L	.035	.047	0.89	1.20	
Lead Thickness	С	.014	.017	0.35	0.44	
Lead 2 Width	В	.017	.022	0.43	0.56	
Leads 1 & 3 Width	B1	.014	.019	0.36	0.48	

<sup>\*</sup>Controlling Parameter

Notes:

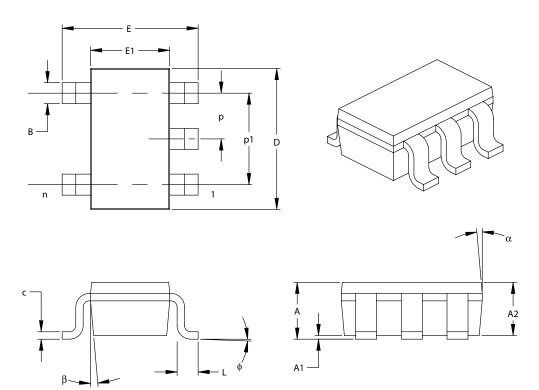
Dimensions D and E1 do not include mold or flash protrusions. Mold flash or protrusions shall not exceed .005" (0.127mm) per side.

JEDEC Equivalent: TO-243

Drawing No. C04-29

Revised 07-24-03

# 5-Lead Plastic Small Outline Transistor (CT) (SOT23)



	Units		INCHES*		N		
Dimension	Limits	MIN	NOM	MAX	MIN	NOM	MAX
Number of Pins	n		5		5		
Pitch	р		.038			0.95	
Outside lead pitch (basic)	p1		.075			1.90	
Overall Height	A	.035	.046	.057	0.90	1.18	1.45
Molded Package Thickness	A2	.035	.043	.051	0.90	1.10	1.30
Standoff	A1	.000	.003	.006	0.00	0.08	0.15
Overall Width	E	.102	.110	.118	2.60	2.80	3.00
Molded Package Width	E1	.059	.064	.069	1.50	1.63	1.75
Overall Length	D	.110	.116	.122	2.80	2.95	3.10
Foot Length	L	.014	.018	.022	0.35	0.45	0.55
Foot Angle	ф	0	5	10	0	5	10
Lead Thickness	С	.004	.006	.008	0.09	0.15	0.20
Lead Width	В	.014	.017	.020	0.35	0.43	0.50
Mold Draft Angle Top	α	0	5	10	0	5	10
Mold Draft Angle Bottom	β	0	5	10	0	5	10

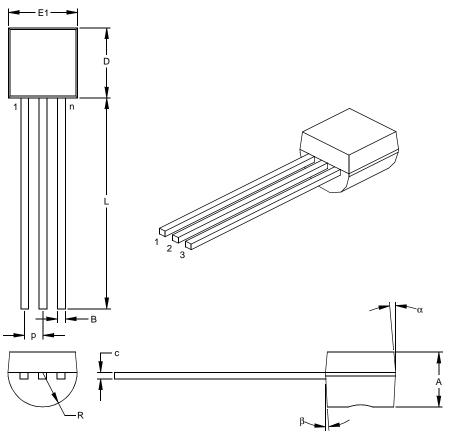
<sup>\*</sup>Controlling Parameter

Notes:

Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .005" (0.127mm) per side.

EIAJ Equivalent: SC-74A Drawing No. C04-091

# 3-Lead Plastic Transistor Outline (ZB) (TO-92)



	Units		INCHES*		MILLIMETERS			
Dimension	Limits	MIN	NOM	MAX	MIN	NOM	MAX	
Number of Pins	n		3			3		
Pitch	р		.050			1.27		
Bottom to Package Flat	Α	.130	.143	.155	3.30	3.62	3.94	
Overall Width	E1	.175	.186	.195	4.45	4.71	4.95	
Overall Length	D	.170	.183	.195	4.32	4.64	4.95	
Molded Package Radius	R	.085	.090	.095	2.16	2.29	2.41	
Tip to Seating Plane	L	.500	.555	.610	12.70	14.10	15.49	
Lead Thickness	С	.014	.017	.020	0.36	0.43	0.51	
Lead Width	В	.016	.019	.022	0.41	0.48	0.56	
Mold Draft Angle Top	α	4	5	6	4	5	6	
Mold Draft Angle Bottom	β	2	3	4	2	3	4	

<sup>\*</sup>Controlling Parameter

Notes:
Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010" (0.254mm) per side.
JEDEC Equivalent: TO-92
Drawing No. C04-101

### PRODUCT IDENTIFICATION SYSTEM

To order or obtain information, e.g., on pricing or delivery, refer to the factory or the listed sales office.

PART NO. X	<u>хх</u>	X	X	X	XX	<u>хх</u>	Exa	amples:	
	Detected Voltage	ı	Tolerance	Temp.		Taping Direction	a)	TC54VC1402ECB71	3: 1.4V Voltage Detector, 2% Tol., SOT-23A-3-TR.
Device:	TC54V:	Voltage D	etector				b)	TC54VC1402EMB71	3:1.4V Voltage Detector, 2% Tol., SOT-89-3-TR.
Output Configuration		h Open-Dr IOS Outpu					c)	TC54VC1402EZB:	1.4V Voltage Detector, 2% Tol., TO-92.
Detected Voltage:	$     \begin{array}{rcl}       14 & = & 1.4 \\       21 & = & 2.1 \\       27 & = & 2.7 \\       29 & = & 2.9 \\       30 & = & 3.0      \end{array} $	V V V					d)	TC54VC2102ECB71	3: 2.1V Voltage Detector, 2% Tol., SOT-23A-3-TR.
	42 = 4.2 43 = 4.3						e)	TC54VC2102EMB71	3:2.1V Voltage Detector, 2% Tol
Extra Feature Code:	0 = Fix	ed						TO: 1/100/100F7D	SOT-89-3-TR.
Tolerance:		(custom) (standard	)				f)	TC54VC2102EZB:	2.1V Voltage Detector, 2% Tol., TO-92.
Temperature:		0°C to +85		. =	<b></b>		g)	TC54VC2702ECB71	3: 2.7V Voltage Detector, 2% Tol., SOT-23A-3-TR.
Package:	MB = 3-F CT = 5-F (7.3	Pin SOT-89 Pin SOT-23 7V ONLY)	A (equivalent BA (equivalent Itline (TO-92),	to EIAJ	,		h)	TC54VC3002ECB71	3: 3.0V Voltage Detector, 2% Tol., SOT-23A-3-TR.
Taping Direction:	713 = Sta	andard Tap	ping				i)	TC54VN4202ECB71	
							j)	TC54VN7702ECT71	

### **Sales and Support**

#### **Data Sheets**

Products supported by a preliminary Data Sheet may have an errata sheet describing minor operational differences and recommended workarounds. To determine if an errata sheet exists for a particular device, please contact one of the following:

- 1. Your local Microchip sales office
- The Microchip Corporate Literature Center U.S. FAX: (480) 792-7277
- 3. The Microchip Worldwide Site (www.microchip.com)

Please specify which device, revision of silicon and Data Sheet (include Literature #) you are using.

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CERTIFIED BY DNV

ISO/TS 16949:2002 ===

Microchip received ISO/TS-16949:2002 quality system certification for its worldwide headquarters, design and wafer fabrication facilities in Chandler and Tempe, Arizona and Mountain View, California in October 2003. The Company's quality system processes and procedures are for its PICmicro® 8-bit MCUs, KEELoo® code hopping devices, Serial EEPROMs, microperipherals, nonvolatile memory and analog products. In addition, Microchip's quality system for the design and manufacture of development systems is ISO 9001:2000 certified.



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